Freescale Semiconductor, Ltd. Form 425 July 02, 2015

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Pursuant to Rule 425

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Subject Company: Freescale Semiconductor, Ltd. (Commission File No. 001-35184)

No Offer or Solicitation

This communication does not constitute an offer to buy or sell or the solicitation of an offer to buy or sell any securities or a solicitation of any vote or approval. This communication relates to a proposed business combination between NXP Semiconductors N.V. (NXP) and Freescale Semiconductor, Ltd. (FSL).

Important Information For Investors and Shareholders

In connection with this proposed business combination, NXP has filed with the Securities and Exchange Commission (the SEC) a registration statement on Form F-4 that includes a definitive joint proxy statement of NXP and FSL that also constitutes a definitive prospectus of NXP. The registration statement was declared effective by the SEC on June 1, 2015. Each of NXP and FSL may file with the SEC other documents in connection with the proposed transaction, INVESTORS AND SECURITY HOLDERS OF NXP AND FSL ARE URGED TO READ THE JOINT PROXY STATEMENT/PROSPECTUS AND OTHER DOCUMENTS THAT ARE FILED OR MAY BE FILED WITH THE SEC CAREFULLY AND IN THEIR ENTIRETY BECAUSE THEY CONTAIN OR WILL CONTAIN IMPORTANT INFORMATION. The definitive joint proxy statement/prospectus will be delivered to shareholders of NXP and FSL on or about June 2, 2015. Investors and security holders are able to obtain free copies of the definitive joint proxy statement/prospectus and other documents filed with the SEC by NXP and/or FSL through the internet website maintained by the SEC at http://www.sec.gov. Copies of the definitive joint proxy statement/prospectus and the other documents filed with the SEC by NXP are also available free of charge on NXP s Investor Relations internet website at http://www.nxp.com/investor or by contacting NXP s Investor Relations Contact by phone at 1-408-518-5411. Copies of the definitive joint proxy statement/prospectus and the other documents filed with the SEC by FSL are available free of charge on FSL s Investor Relations internet website at http://investors.freescale.com or by writing to Freescale Semiconductor, Ltd., c/o Freescale Semiconductor, Inc., 6500 William Cannon Drive West, Austin, Texas 78735, Attention: Investor Relations or by phone at 1-512-895-2454.

Forward Looking Statements

Certain statements in this communication regarding the proposed transaction between NXP and FSL are forward-looking statements. The words anticipate, believe. probab ensure, expect, intend, estimate, forecasts, predict, outlook. will. could. should, potential, might, aim. would, may, anticipate, strategy, and similar expressions, and the negative thereof, are intended to identify forward-looking statements. These forward-looking statements, which are subject to numerous factors, risks and uncertainties about NXP and FSL, may include projections of their respective future business, strategies, financial condition, results of operations and market data. These statements are only predictions based on current expectations and projections about future events. There are important factors, risks and uncertainties that could cause actual outcomes and results to be materially different

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from those projected, including the risk factors set forth in the definitive joint proxy statement/prospectus, NXP s most recent Form 20-F and FSL s most recent reports on Form 10-K, Form 10-Q and other documents on file with the SEC and the factors given below:

the failure to consummate or delay in consummating the proposed transaction;

the timing to consummate the proposed transaction;

the risk that a condition to closing of the proposed transaction may not be satisfied;

the risk that a regulatory approval that may be required for the proposed transaction is delayed, is not obtained, or is obtained subject to conditions that are not anticipated;

NXP s and FSL s ability to achieve the synergies and value creation contemplated by the proposed transaction;

the ability of either NXP or FSL to effectively integrate their businesses; and

the diversion of management time on transaction-related issues.

FSL s and NXP s forward-looking statements are based on assumptions that may not prove to be accurate. Neither FSL nor NXP can guarantee future results, level of activity, performance or achievements. Moreover, neither FSL nor NXP assumes responsibility for the accuracy and completeness of any of these forward-looking statements. FSL and NXP assume no obligation to update or revise any forward-looking statements as a result of new information, future events or otherwise. Readers are cautioned not to place undue reliance on these forward-looking statements that speak only as of the date hereof.

The following is a message sent to NXP employees on July 2, 2015.

SHAREHOLDERS MEETINGS APPROVE NXP FREESCALE MERGER

Thursday, July 2, 2015

To: All NXP employees

We have reached a significant milestone in our proposed merger with Freescale. Separate meetings for each company s shareholders were held today, with a resounding positive outcome. Both NXP s Special Meeting and Freescale s Special General Meeting approved the merger proposal with over 99% of the votes cast in favor of the merger, clearing the path for the remaining stages of the process. Today the NXP Shareholders Meeting also appointed Gregory L. Summe and Peter Smitham, currently board members of Freescale, as non-executive directors of NXP, effective as of Day One.

With the overwhelming support of our shareholders, we continue finalizing the creation of a true industry powerhouse. The Smarter World ahead of us offers significant growth opportunities for NXP, in a range of markets including Automotive and IoT. We are confident that the combined strengths of our two companies will enable us to significantly outgrow the overall market, reinforcing our position as a key player in the semiconductor industry.

Work continues on the remaining steps in the process. For a recap of events and steps we have covered to date, including organizational charts and previous integration updates, please visit our dedicated <u>Integration Hub</u>.

Rick Clemmer CEO